

# UTC UNISONIC TECHNOLOGIES CO., LTD

4N70-R **Preliminary Power MOSFET** 

## **4A, 700V N-CHANNEL POWER MOSFET**

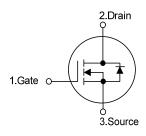
#### **DESCRIPTION**

The UTC 4N70-R is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche. This high speed switching power MOSFET is usually used in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

#### **FEATURES**

- \*  $R_{DS(ON)} < 2.8\Omega @V_{GS} = 10 \text{ V}$
- \* Ultra Low Gate Charge (Typical 16nC)
- \* Low Reverse Transfer Capacitance ( C<sub>RSS</sub> = Typical 6 pF )
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness

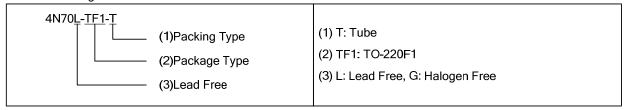
#### **SYMBOL**



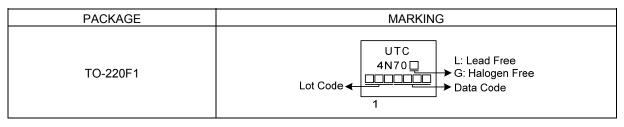
#### **ORDERING INFORMATION**

Ordering Number		Dooksons	Pin	Assignm	Deaking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
4N70L-TF1-T	4N70G-TF1-T	TO-220F1	G	D	S	Tube	

Pin Assignment: G: Gate D: Drain S: Source



#### MARKING INFORMATION



TO-220F1

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### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	700	V
Gate-Source Voltage		$V_{GSS}$	±30	V
Avalanche Current (Note 2)		I <sub>AR</sub>	4	Α
Drain Current	Continuous	Ι <sub>D</sub>	4	Α
	Pulsed (Note 2)	I <sub>DM</sub>	16	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	55	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		$P_{D}$	36	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T <sub>OPR</sub>	-55 ~ +150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature
- 3. L = 6.87mH,  $I_{AS}$  = 4A,  $V_{DD}$  = 50V,  $R_{G}$  = 25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 4.4A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT		
Junction to Ambient	$\theta_{JA}$	62.5	°C/W		
Junction to Case	θ <sub>JC</sub>	3.47	°C/W		

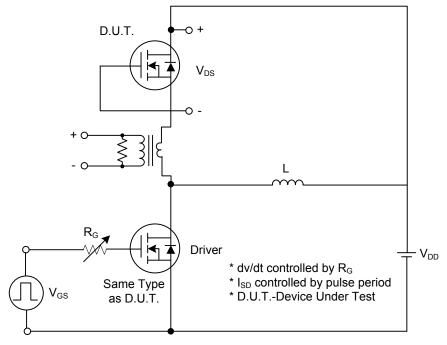
## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 700 \text{ V}, V_{GS} = 0 \text{ V}$			10	μA	
Cata Cauras I sakana Currant	Forward	I <sub>GSS</sub>	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	Λ	
Gate-Source Leakage Current	Reverse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS} \! / \triangle T_J$	I <sub>D</sub> = 250μA, Referenced to 25°C		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.2 A		3.3	3.8	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		$C_{ISS}$	.,		450	690	pF	
Output Capacitance		Coss	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1MHz		45	90	pF	
Reverse Transfer Capacitance		$C_{RSS}$			6	11	pF	
SWITCHING CHARACTERISTICS	S							
Turn-On Delay Time Turn-On Rise Time		$t_{D(ON)}$			72	90	ns	
		$t_R$	$V_{DD} = 30V, I_D = 0.5A,$		32	50	ns	
Turn-Off Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega \text{ (Note 1, 2)}$		50	70	ns	
Turn-Off Fall Time		$t_{F}$			40	60	ns	
Total Gate Charge		$Q_G$	V <sub>DS</sub> = 50V, I <sub>D</sub> = 1.3A, V <sub>GS</sub> = 10 V (Note 1, 2)		16	20	nC	
Gate-Source Charge		$Q_GS$			5.6		nC	
Gate-Drain Charge		$Q_GD$	V <sub>GS</sub> - 10 V (Note 1, 2)		3.4		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		$V_{SD}$	$V_{GS} = 0 \text{ V}, I_{S} = 4.4 \text{ A}$			1.4	V	
Maximum Continuous Drain-Source Diode		Is				4.4	^	
Forward Current						4.4	Α	
Maximum Pulsed Drain-Source Diode		la				17.6	Α	
Forward Current		I <sub>SM</sub>				17.0	^	
Reverse Recovery Time		t <sub>rr</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 4.4 A,		250		ns	
Reverse Recovery Charge		$Q_{RR}$	dl/dt = 100 A/µs (Note 1)		1.5		μC	

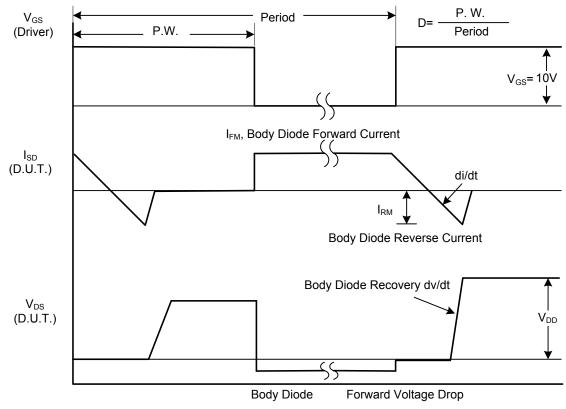
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

<sup>2.</sup> Essentially independent of operating temperature

#### ■ TEST CIRCUITS AND WAVEFORMS

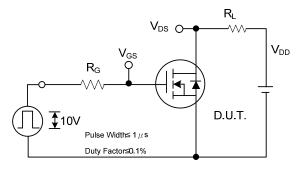


Peak Diode Recovery dv/dt Test Circuit

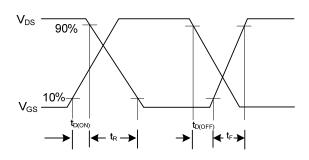


Peak Diode Recovery dv/dt Waveforms

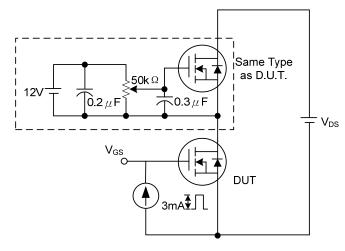
## ■ TEST CIRCUITS AND WAVEFORMS (Cont.)



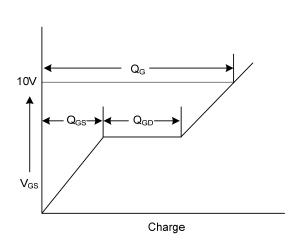
**Switching Test Circuit** 



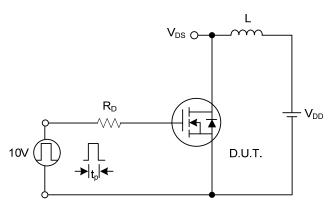
**Switching Waveforms** 



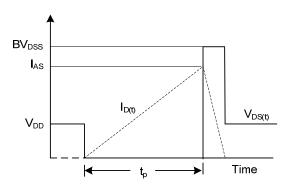
**Gate Charge Test Circuit** 



**Gate Charge Waveform** 



**Unclamped Inductive Switching Test Circuit** 



**Unclamped Inductive Switching Waveforms** 

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